



MCP7Y70-H001-OPC

Mellanox® MCP7Y70-H001 Compatible TAA 400GBase-CU OSFP to 4xQSFP56 Direct Attach Cable (Passive Twinax, 1m)

Features

- OSFP Module Compliant to OSFP MSA
- QSFP Module Compliant to SFF-8665
- Transmission Data Rate up to 53.125Gbps Per Channel
- Enable 400Gbps to 400Gbps Transmission
- Built-In EEPROM Functions
- Operating Temperature Range: 0 to 70 Celsius
- RoHS Compliant and Lead-Free



Applications:

- 400GBase Ethernet

Product Description

This is a Mellanox® MCP7Y70-H001 compatible 400GBase-CU OSFP to 4xQSFP56 direct attach cable that operates over passive copper with a maximum reach of 1.0m (3.3ft). It has been programmed, uniquely serialized, and data-traffic and application tested to ensure it is 100% compliant and functional. This direct attach cable is TAA (Trade Agreements Act) compliant, and is built to comply with MSA (Multi-Source Agreement) standards. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

OptioConnect's transceivers are RoHS compliant and lead-free.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	Vcc	3.13	3.3	3.47	V
Storage Temperature	Tstg	-40		85	°C
Operating Case Temperature	Tc	0		70	°C
Relative Humidity	RH	5		85	%
Data Rate			400		Gbps

Electrical Specifications

Parameter	Symbol	Min.	Typ.	Max.	Unit
Resistance	Rcon			3	Ω
Insulation Resistance	Rins			10	MΩ
Raw Cable Impedance	Zca	95	100	110	Ω
Mated Connector Impedance	Zmated	85	100	110	Ω
Insertion Loss @13.28GHz	SDD21	6		14	dB
Return Loss	SDD11/22	$\text{Return_loss}(f) \geq \begin{cases} 11 & 0.05 \leq f < 26.5625/7.5 \\ 6.0-9.2\lg(15f/5.5*7.26.5625) & 26.5625/7.5 \leq f \leq 26.5 \end{cases}$			dB
Differential to Common-Mode Return Loss	SCD11/22	$\text{Return_loss}(f) \geq \begin{cases} -25+(20/26.5625)f & 0.05 \leq f < 26.5625/2 \\ -18+(6/26.5625)f & 26.5625/2 \leq f \leq 26.5625 \end{cases}$			dB
Differential to Common-Mode Conversion Loss	SCD21-SDD21	$\text{Conversion_loss}(f) - \text{IL}(f) \geq \begin{cases} 10 & 0.01 \leq f < 12.89 \\ 27-(29/22)f & 12.89 \leq f < 15.7 \\ 6.3 & 15.7 \leq f \leq 19 \end{cases}$			dB
Minimum COM	COM	3			dB

Physical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Length	L		1		M
Wire Gauge			30		AWG
Jacket Material		Plastic Braided Mesh, Silver Gray			

Pin Descriptions for OSFP

Pin	Symbol	Name/Description	Logic	Plug Sequence	Direction	Notes
1	GND	Module Ground.		1		
2	Tx2+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
3	Tx2-	Transmitter Data Inverted.	CML-I	3	Input from Host	
4	GND	Module Ground.		1		
5	Tx4+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
6	Tx4-	Transmitter Data Inverted.	CML-I	3	Input from Host	
7	GND	Module Ground.		1		
8	Tx6+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
9	Tx6-	Transmitter Data Inverted.	CML-I	3	Input from Host	
10	GND	Module Ground.		1		
11	Tx8+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
12	Tx8-	Transmitter Data Inverted.	CML-I	3	Input from Host	
13	GND	Module Ground.		1		
14	SCL	2-Wire Serial Interface Clock.	LVC MOS-I/O	3	Bi-Directional	1
15	Vcc	+3.3V Power.		2	Power from Host	
16	Vcc	+3.3V Power.		2	Power from Host	
17	LPWn/PRSn	Low-Power Mode/Module Present.	Multi-Level	3	Bi-Directional	2
18	GND	Module Ground.		1		
19	Rx7-	Receiver Data Inverted.	CML-O	3	Output to Host	
20	Rx7+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
21	GND	Module Ground.		1		
22	Rx5-	Receiver Data Inverted.	CML-O	3	Output to Host	
23	Rx5+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
24	GND	Module Ground.		1		
25	Rx3-	Receiver Data Inverted.	CML-O	3	Output to Host	
26	Rx3+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
27	GND	Module Ground.		1		
28	Rx1-	Receiver Data Inverted.	CML-O	3	Output to Host	
29	Rx1+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
30	GND	Module Ground.		1		
31	GND	Module Ground.		1		
32	Rx2+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
33	Rx2-	Receiver Data Inverted.	CML-O	3	Output to Host	
34	GND	Module Ground.		1		
35	Rx4+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
36	Rx4-	Receiver Data Inverted.	CML-O	3	Output to Host	
37	GND	Module Ground.		1		
38	Rx6+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
39	Rx6-	Receiver Data Inverted.	CML-O	3	Output to Host	
40	GND	Module Ground.		1		

41	Rx8+	Receiver Data Non-Inverted.	CML-O	3	Output to Host	
42	Rx8-	Receiver Data Inverted.	CML-O	3	Output to Host	
43	GND	Module Ground.		1		
44	INT/RSTn	Module Interrupt/Module Reset.	Multi-Level	3	Bi-Directional	2
45	Vcc	+3.3V Power.		2	Power from Host	
46	Vcc	+3.3V Power.		2	Power from Host	
47	SDA	2-Wire Serial Interface Data.	LVC MOS-I/O	3	Bi-Directional	1
48	GND	Module Ground.		1		
49	Tx7-	Transmitter Data Inverted.	CML-I	3	Input from Host	
50	Tx7+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
51	GND	Module Ground.		1		
52	Tx5-	Transmitter Data Inverted.	CML-I	3	Input from Host	
53	Tx5+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
54	GND	Module Ground.		1		
55	Tx3-	Transmitter Data Inverted.	CML-I	3	Input from Host	
56	Tx3+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
57	GND	Module Ground.		1		
58	Tx1-	Transmitter Data Inverted.	CML-I	3	Input from Host	
59	Tx1+	Transmitter Data Non-Inverted.	CML-I	3	Input from Host	
60	GND	Module Ground.		1		

Notes:

1. Open-drain with pull-up resistor on the host.
2. See pin assignments below for the required circuit.

Electrical Pin-Out Details - OSFP

Top Side (viewed from top)

60	GND
59	TX1p
58	TX1n
57	GND
56	TX3p
55	TX3n
54	GND
53	TX5p
52	TX5n
51	GND
50	TX7p
49	TX7n
48	GND
47	SDA
46	VCC
45	VCC
44	INT/RSTn
43	GND
42	RX8n
41	RX8p
40	GND
39	RX6n
38	RX6p
37	GND
36	RX4n
35	RX4p
34	GND
33	RX2n
32	RX2p
31	GND

----- Module Card Edge -----

Bottom Side (viewed from bottom)

	GND	1
	TX2p	2
	TX2n	3
	GND	4
	TX4p	5
	TX4n	6
	GND	7
	TX6p	8
	TX6n	9
	GND	10
	TX8p	11
	TX8n	12
	GND	13
	SCL	14
	VCC	15
	VCC	16
	LPWn/PR5n	17
	GND	18
	RX7n	19
	RX7p	20
	GND	21
	RX5n	22
	RX5p	23
	GND	24
	RX3n	25
	RX3p	26
	GND	27
	RX1n	28
	RX1p	29
	GND	30

Pin Descriptions for QSP56

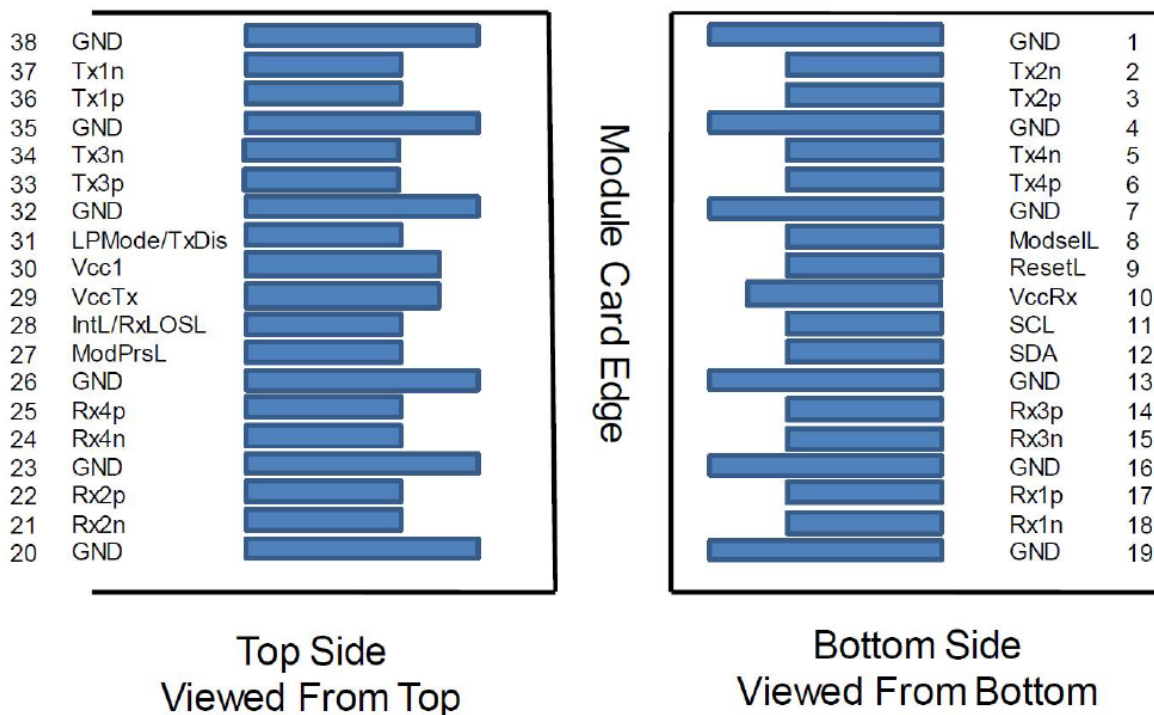
Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3	
4		GND	Module Ground.	1	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3	
7		GND	Module Ground.	1	1
8	LVTTL-I	ModSelL	Module Select.	3	
9	LVTTL-I	ResetL	Module Reset.	3	
10		VccRx	+3.3V Receiver Power Supply.	2	2
11	LVC MOS-I/O	SCL	2-Wire Serial Interface Clock.	3	
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data.	3	
13		GND	Module Ground.	1	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3	
16		GND	Module Ground.	1	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3	
19		GND	Module Ground.	1	1
20		GND	Module Ground.	1	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3	
23		GND	Module Ground.	1	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3	
26		GND	Module Ground.	1	1
27	LVTTL-O	ModPrsL	Module Present.	3	
28	LVTTL-O	IntL	Interrupt.	3	
29		VccTx	+3.3V Transmitter Power Supply.	2	2
30		Vcc1	+3.3V Power Supply.	2	2
31	LVTTL-I	LPMODE	Low-Power Mode.	3	
32		GND	Module Ground.	1	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	3	
35		GND	Module Ground.	1	1

36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3	
38		GND	Module Ground.	1	1

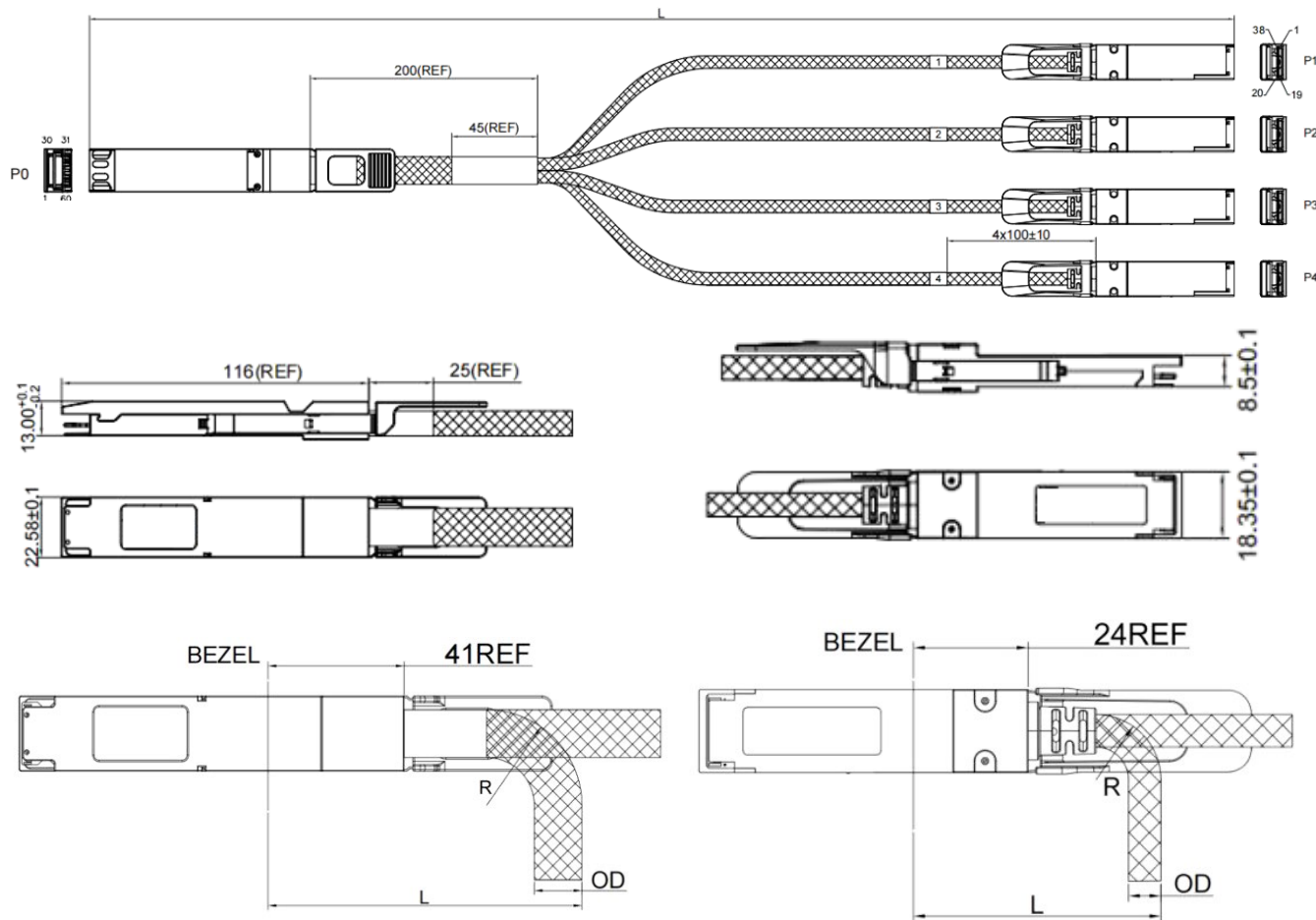
Notes:

1. GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, Vcc1, and VccTx are the receiver and transmitter power supplies and shall be applied concurrently. VccRx, Vcc1, and VccTx may be internally connected within the QSFP transceiver module in any combination. The connector pins are each rated for a maximum current of 500mA.

Electrical Pin-Out Details - QSFP



Mechanical Specifications



OSFP				QSFP-DD			
Gauge	OD	Bend Radius "R"	Min. Bend Radius "L"	Gauge	OD	Bend Radius "R"	Min. Bend Radius "L"
30AWG	9.5MM	19MM	80MM	30AWG	5.7MM	12MM	46MM

OptioConnect

Innovation for the Future of High-Speed Networking

Who We Are

OptioConnect is reshaping the landscape of communication and high-speed networking through intelligent technology. With a core focus on cutting edge technology, we deliver smarter fiber optic solutions for enterprise networks, data centers, and next-gen telecom infrastructures.

What We Do

At OptioConnect, we fuse advanced engineering with intelligent automation to drive the future of networking. Our AI-integrated solutions are designed to optimize performance and streamline operations with:

- Superior Performance
- Network and traffic optimization
- Intelligent energy management
- Seamless OEM compatibility
- Scalable cost-efficiency

Smarter Networks by Design

Innovation isn't just a goal—it's our process. We embed AI and machine learning across our R&D and product lines, enabling adaptive performance, automated tuning, and faster deployment cycles. The result? Networks that don't just work—they learn, evolve, and outperform.

Our Team

Our engineers, data scientists, and network architects bring decades of experience and a future-focused mindset. We provide hands-on support with intelligent insights that turn complex challenges into simple solutions.

Our Mission

To deliver AI-enhanced connectivity that reduces cost, increases speed, and maximizes efficiency—empowering our partners to operate at the forefront of a rapidly evolving digital world.

Let's Connect

Discover how OptioConnect's intelligent infrastructure solutions can power your network's next leap forward.

www.optioconnect.com | info@optioconnect.com

